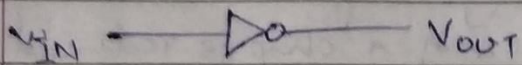


Class	:	BE - 8
Roll. No	:	42410
Assignment No.	:	B.1 a
Assignment Name	:	CMOS Inverter
Date of Performance	:	03-11-2020, 21-11-2020

Assignment 1: -

(1.a) CMOS INVERTER

SYMBOL	O/P	VALUE OF V_{OUT} (V)
	STRONG 1	$+V_{DD}$
	WEAK-1	$< +V_{DD}$
	STRONG 0	$-V_{SS} (0)$
	WEAK-0	> 0

TRUTH TABLE

V_{IN}	$V_{OUT} = \overline{V_{IN}}$
0	STRONG-1
1	STRONG-0

* for 90nm technology

$$V_{DD} = +1.2V$$

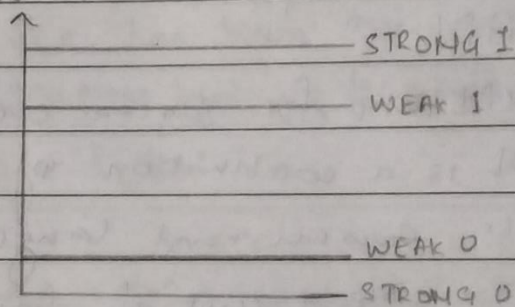
$$* P_{dyn} = C_L (V_{DD})^2 \cdot f$$

$$- P_{dyn} \propto C_L$$

$$\propto (V_{DD})^2$$

$$\propto f$$

$V_{OUT}(V)$



Block Diagram

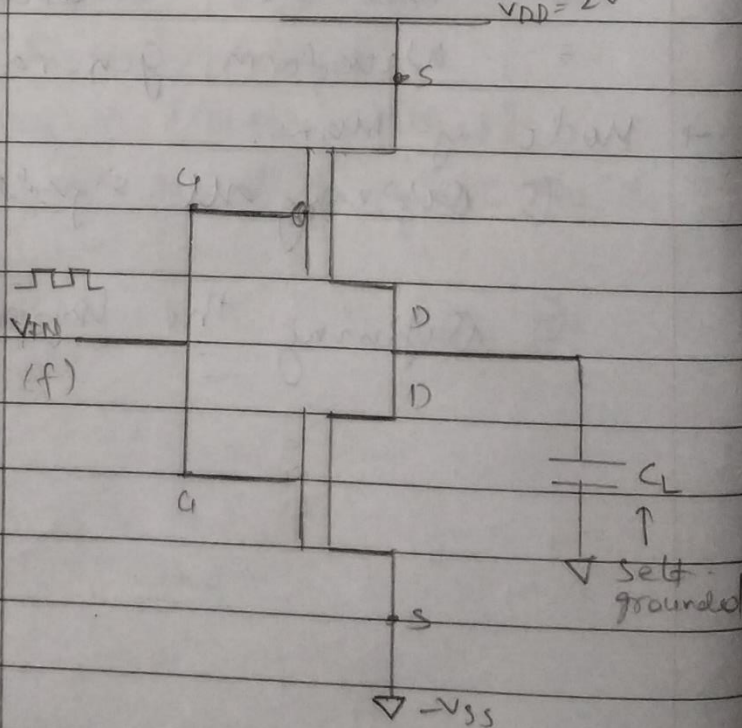
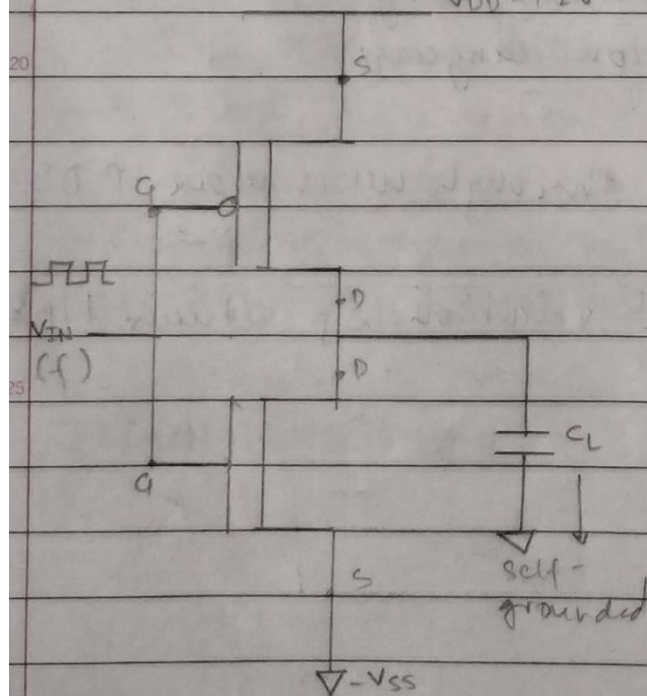
Schematics:

* $f = 90 \text{ nm}$

$V_{DD} = 1.2 \text{ V}$

* $f = 180 \text{ nm}$

$V_{DD} = 2 \text{ V}$



$$\textcircled{*} p = \frac{w_p}{L_p} = \left(\frac{500}{100} \right) \text{ nm} = 5$$

$$\textcircled{*} p = \frac{w_p}{L_p} = \left(\frac{1000}{200} \right) \text{ nm} = 5$$

$$\textcircled{*} n = \frac{w_n}{L_n} = \left(\frac{500}{100} \right) \text{ nm} = 5$$

$$\textcircled{*} n = \frac{w_n}{L_n} = \left(\frac{1000}{200} \right) \text{ nm} = 5$$

$$\textcircled{+} \frac{P}{P} = 1$$

$\textcircled{+}$ Nominal Values :-

$$C_L = 0.1 \text{ pF}$$

$$f = 2.5 \text{ GHz}$$

$$C_L' = 0.005 \text{ pF}$$

$$C_L'' = 0.02 \text{ pF}$$

$$f' = 1.25 \text{ GHz}$$

$$f'' = 5 \text{ GHz}$$

$$\textcircled{+} \frac{P}{P} = 1$$

Nominal Values: -

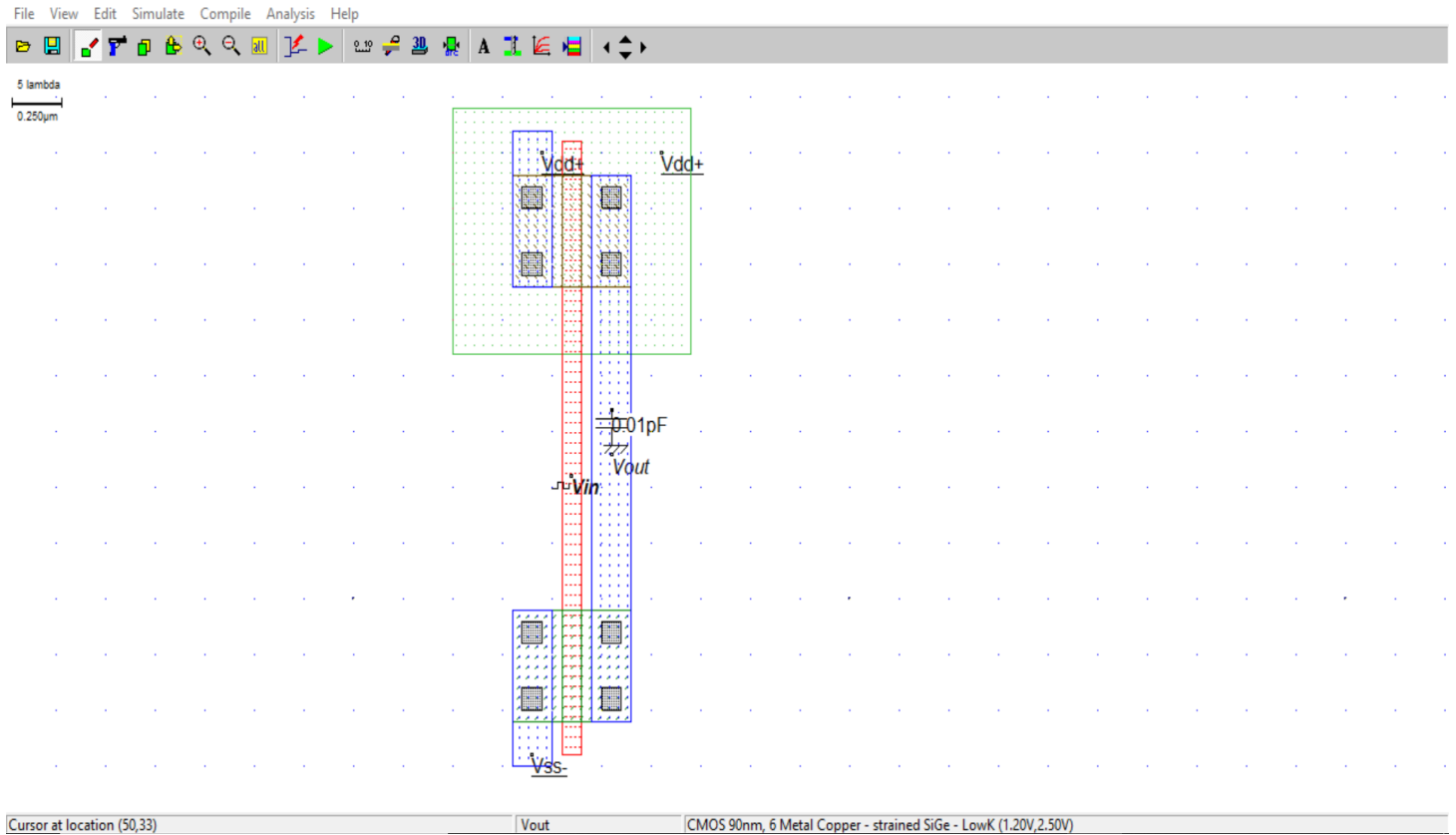
$$C_L = 0.01 \text{ pF}$$

$$f = ~~2.5~~ 2.5 \text{ GHz}$$

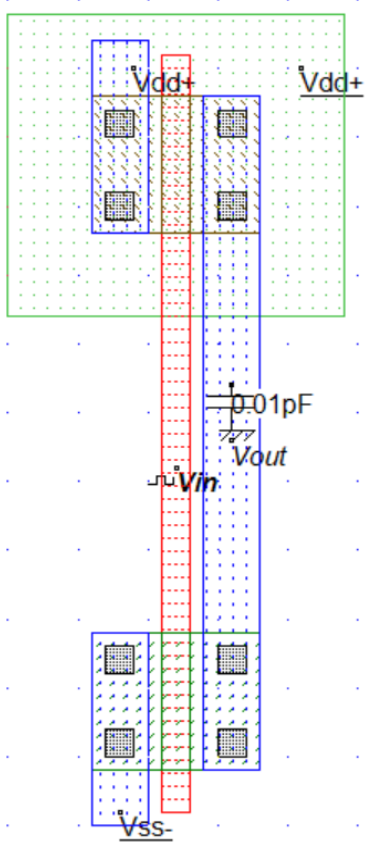
C_L, f are not varied

LAYOUT

1) CMOS Inverter with 90nm Foundry



2) CMOS Inverter with 180 nm foundry



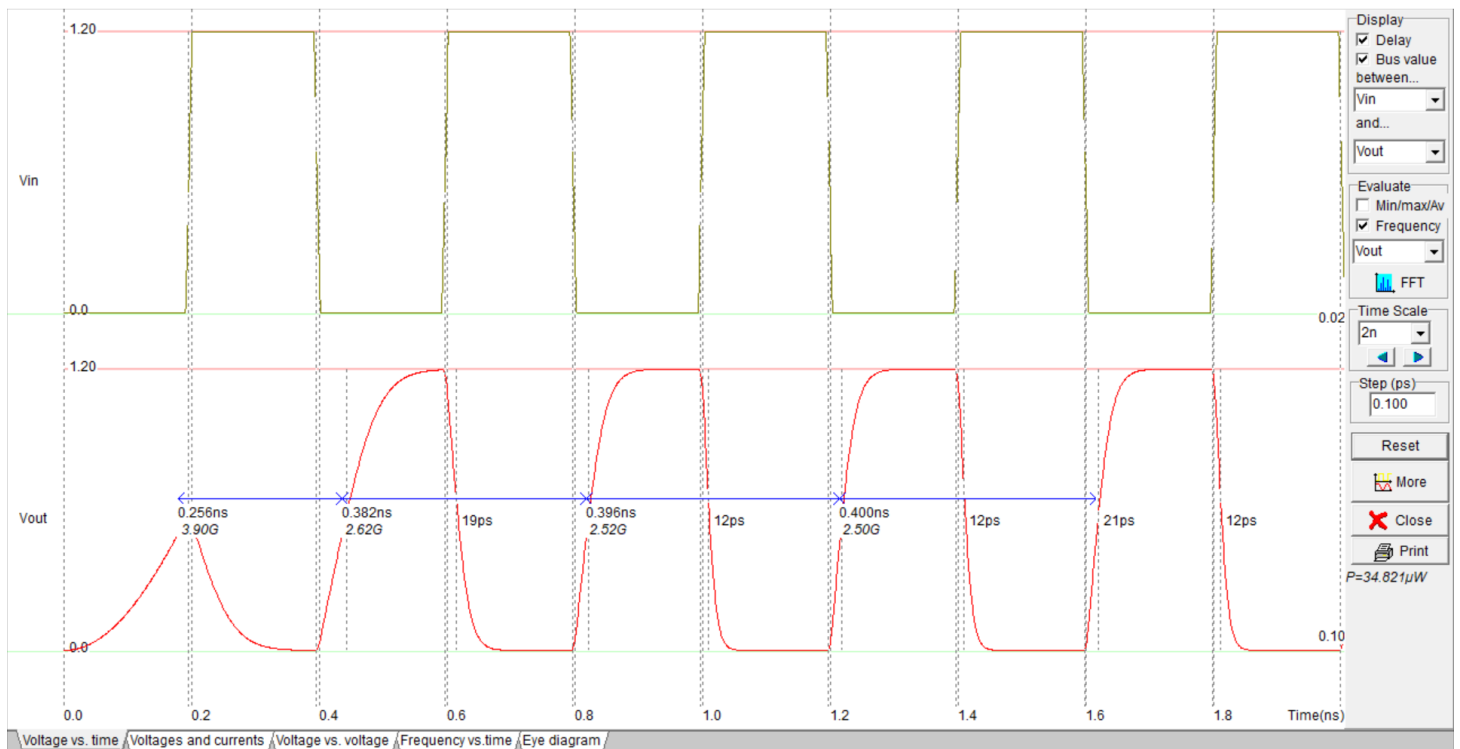
Palette

Options 0m
Metal 6 0m
Metal 5 0m
Metal 4 0m
Metal 3 0m
Metal 2 0m
Metal 1 0m
Polysilicon 2 0m
Contact 0m
Polysilicon 0m
P+ Diffusion 0m
N+ Diffusion 0m
N Well 0m

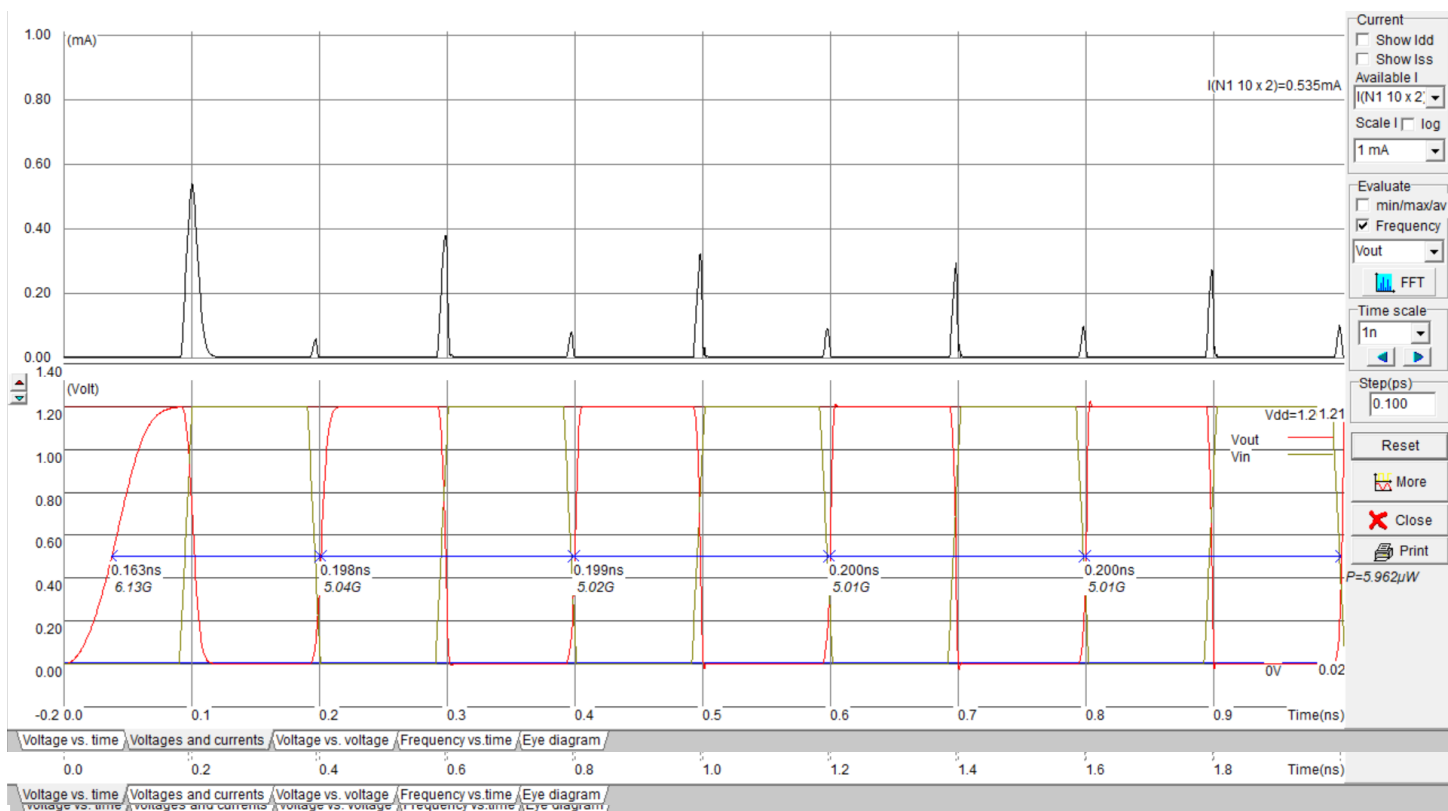
Vdd CMOS 0.18μm - 6 Metal (2.00V, 3.30V)

WAVEFORMS

1) V_{in} , V_{out}



2) V_{out} , I_{out}



SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	5.962 μW
2)		f_{max}	5 GHz

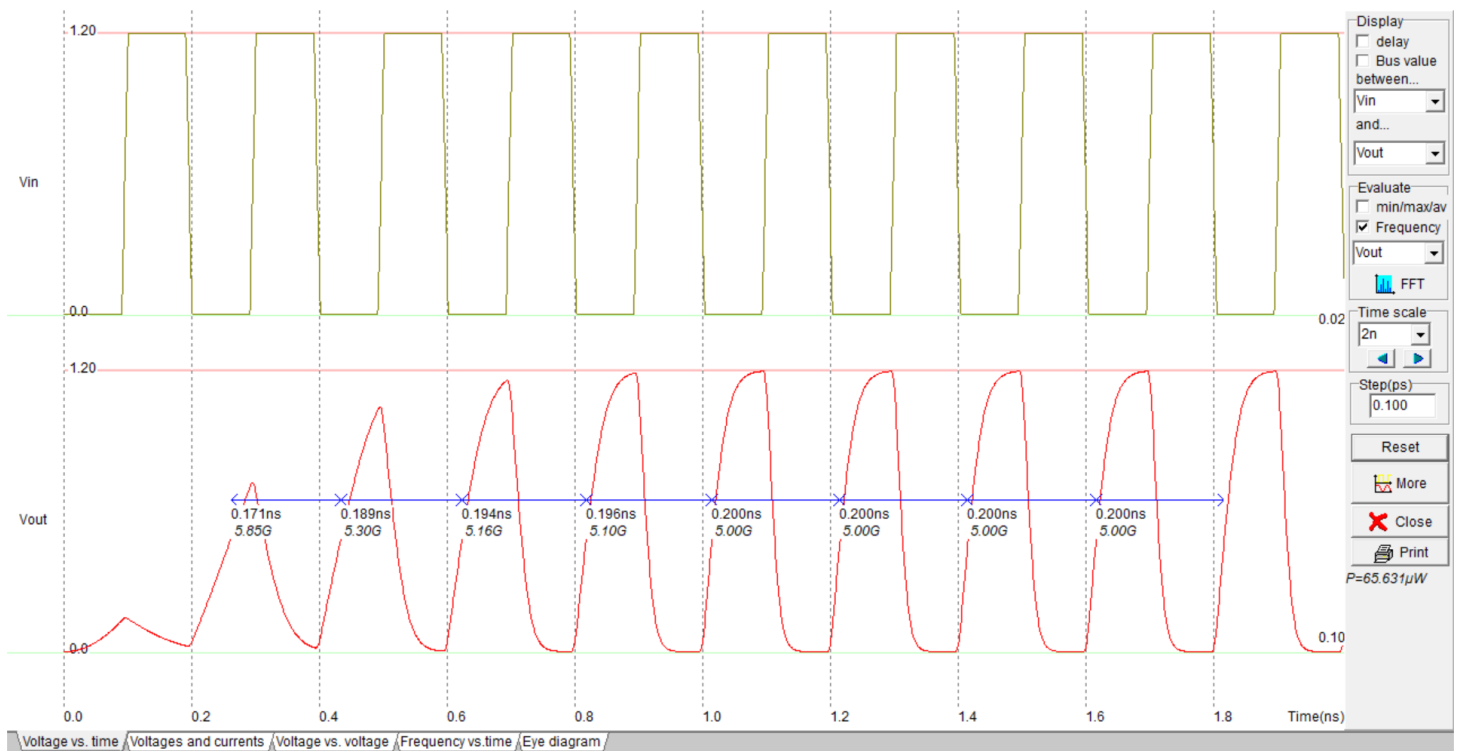
a) $f = 2.5 \text{ GHz}$, $C = 0.02 \text{ uF}$, $V_{dd} = 1.2 \text{ V}$

SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	62.402 μW
2)		f_{max}	2.5 GHz

b) $f = 2.5 \text{ GHz}$, $C = 0.005 \text{ uF}$, $V_{dd} = 1.2 \text{ V}$

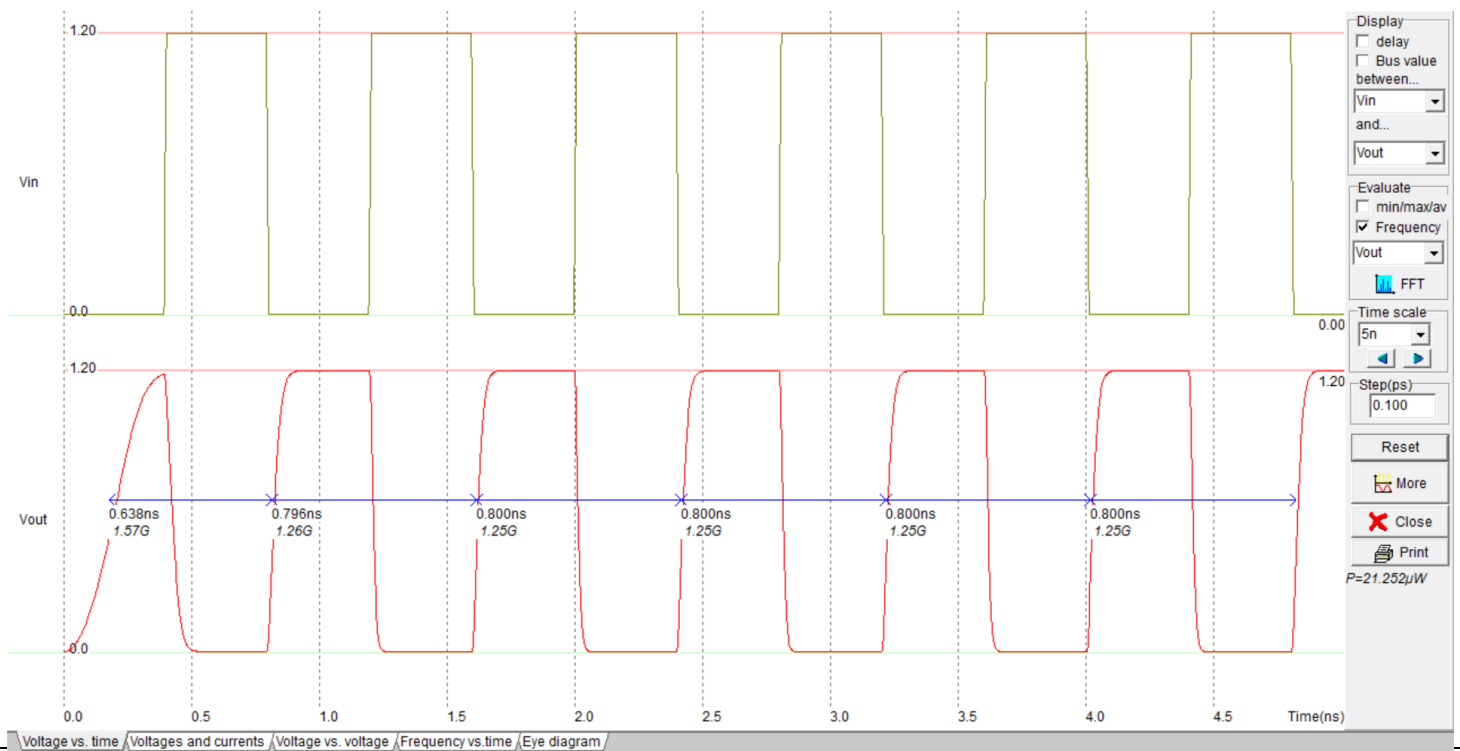
SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	20.062 μW
2)		f_{max}	2.5 GHz

c) $f = 5 \text{ GHz}$, $C = 0.01 \text{ u F}$, $V_{dd} = 1.2 \text{ V}$



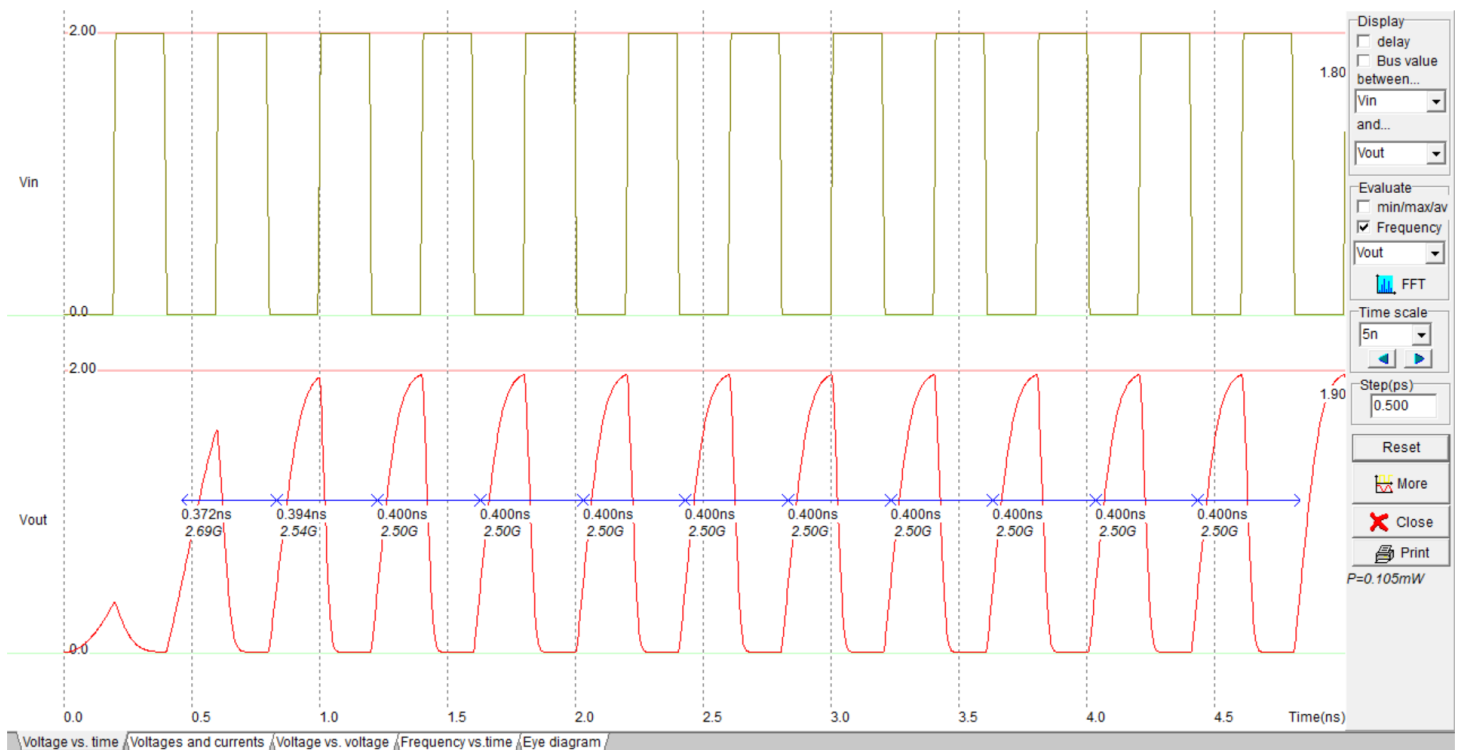
SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	65.631 μW
2)		f_{max}	5 GHz

d) $f = 1.25 \text{ GHz}$, $C = 0.01 \text{ uF}$, $V_{dd} = 1.2 \text{ V}$



SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	21.252 μ W
2)		f_{max}	1.25 GHz

e) $f = 2.5$ GHz, $C = 0.01$ uF, $V_{dd} = 2$ V



SR.NO.		PARAMETER	VALUE
1)		$P_{dynamic}$	0.105 mW
2)		f_{max}	2.5 GHz

Conclusions:

Thus, we have:

- 1) Drawn the LAYOUT for CMOS Inverter using 90 nm & 180 nm Foundry.
- 2) Simulated the LAYOUT to observe waveforms & verified its functionality as per TRUTH-TABLE.
- 3) Noted the values of $P_{dynamic}$ for floating Load.

- 4) Appreciated the validity of the mathematical model: $P_{\text{dynamic}} = C_L * (V_{\text{dd}})^2 * f_{\text{clk}}$
by Doubling & Halving the values of C_L & f_{clk}
- 5) Found a reduction in P_{dynamic} by using a better Foundry i.e., 90 nm instead of 180 nm
- 6) Learnt that the presence of spikes in O / P waveform at Switching instants indicate the inability of the MOSFETs to switch at GHz frequencies.
- 7) Learnt that the using a better Foundry enables the MOSFETs the inability of the MOSFETs to switch at Higher GHz frequencies, as proved by the removal of Spikes at the O/P.